

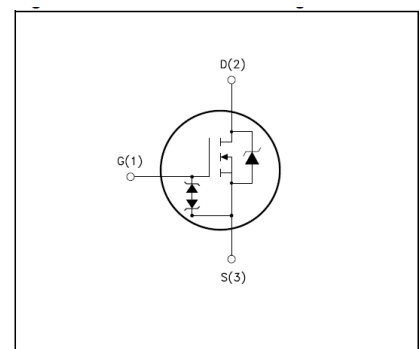
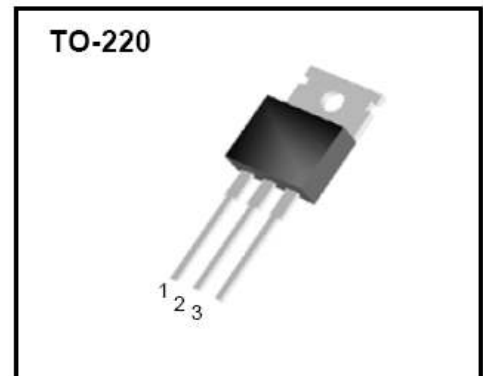
N-Channel MOSFET

Features

- ◆ $R_{DS(ON)}$ Max 1.0 ohm at $V_{GS} = 10V$
- ◆ Gate Charge (Typical 18nC)
- ◆ Improve dv/dt capability, Fast switching
- ◆ 100% avalanche Tested

General Description

This MOSFET is produced using advanced planar strip DMOS technology. This latest technology has been especially designed to minimize on-state resistance have a high rugged avalanche characteristics. These device are well suited for high efficiency switch mode power supply active power factor correction. Electronic lamp based on half bridge topology



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain-Source Voltage	400	V
I_D	Drain Current $T_C=25^\circ\text{C}$ $T_C=100^\circ\text{C}$	6.5 2.9	A
V_{GSS}	Gate-Source Voltage	± 30	V
I_{DM}	Drain Current pulse (Note 1)	24	A
E_{AS}	Single Pulse Avalanche Energy (Note 2)	335	mJ
E_{AR}	Repetitive Avalanche Energy (Note 1)	8.5	mJ
dv/dt	Peak diode Recovery dv/dt (Note 3)	4.5	V/ns
P_D	Power Dissipation $T_C=25^\circ\text{C}$	76	W
T_J, T_{STG}	Operation and Storage Temperature range	-45 ~ 150	$^\circ\text{C}$

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Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.65	$^{\circ}\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance Case to Sink Typ.	0.5	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	62.5	$^{\circ}\text{C}/\text{W}$

Electrical Characteristics (TC = 25 $^{\circ}\text{C}$ Unless otherwise noted)

Symbol	Items	Conditions	Ratings			Unit
			Min	Typ.	Max	
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$	400			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature coefficient	$I_D = 250\mu\text{A}$, Reference to 25 $^{\circ}\text{C}$		0.6		V/ $^{\circ}\text{C}$
I_{DSS}	Zero gate voltage Drain Current	$V_{DS} = 400\text{V}, V_{GS} = 0\text{V}$ $V_{DS} = 320\text{V}, T_S = 125^{\circ}\text{C}$			1 10	μA
I_{GSSF}	Gate body leakage current Forward	$V_{GS} = 30\text{V}, V_{DS} = 0\text{V}$			100	nA
I_{GSSR}	Gate body leakage current Reverse	$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}$			-100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	2.0		4.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 3.0\text{A}$		0.75	1.0	Ω

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{V}$ $f = 1.0\text{MHz}$		520		pF
C_{oss}	output Capacitance			80		pF
C_{rss}	Reverse Transfer Capacitance			15		pF

Switching Characteristics

Symbol	Items	Conditions	Min	Typ.	Max	Units
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = 200V, I_D = 6.0A$ $R_G = 25 \Omega$ (note 4,5)		15		ns
t_r	Turn-on Rise Time			65		ns
$t_{d(off)}$	Turn-off Delay Time			20		ns
t_f	Turn-off Fall Time			40		ns
Q_g	Total Gate Charge	$V_{DS} = 320V, I_D = 6.0A$ $V_{GS} = 10V$ (note 4,5)		18		nC
Q_{gs}	Gate-Source Charge			2.5		nC
Q_{gd}	Gate-Drain Charge			8.5		nC

Drain-Source Diode Characteristics

I_S	Maximum Continuous Drain-Source diode Forward Current			6.0	A
I_{SM}	Maximum Pulse Drain-Source diode Forward Current			24.0	A
V_{SD}	Drain-Source diode Forward voltage	$V_{GS} = 0V, I_S = 6.0A$		1.4	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_S = 6.0A$ $dI_F/dt = 100 A/us$ (note 4)		230	nS
Q_{rr}	Reverse Recovery Charge			1.8	uC

Notes

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 17mH, I_{AS} = 6.0A, V_{DD} = 50V, R_G = 25 \Omega$, starting $T_J = 25^\circ C$
3. $I_{SD} \leq 6.0A, di/dt \leq 200A/us, V_{DD} \leq BV_{DSS}$, starting $T_J = 25^\circ C$
4. Pulse Test : Pulse width $\leq 300us$, Duty cycle $\leq 2\%$
5. Essentially independent of operation temperature

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Fig. 1 On-State Characteristics

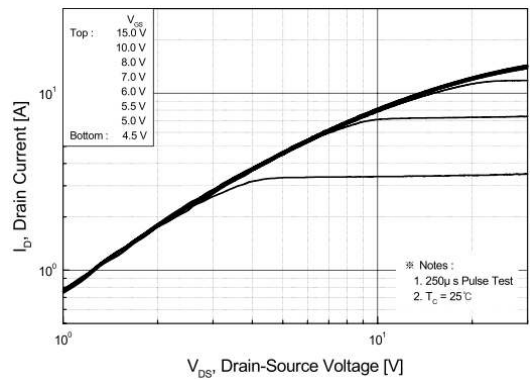


Fig. 2 On-Resistance variation vs Drain Current
And gate Voltage

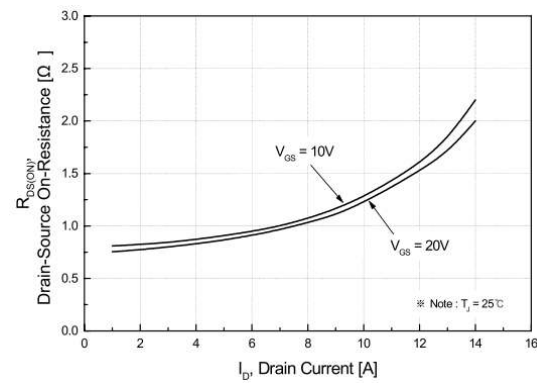


Fig. 3 Breakdown Voltage Variation vs
Temperature

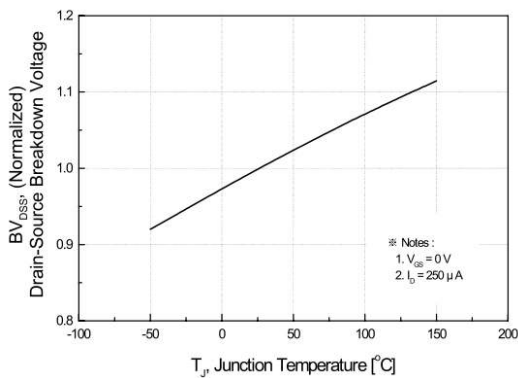


Fig. 4. On-Resistance Variation vs Temperature

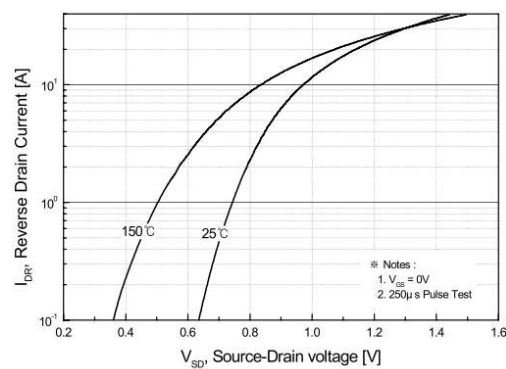
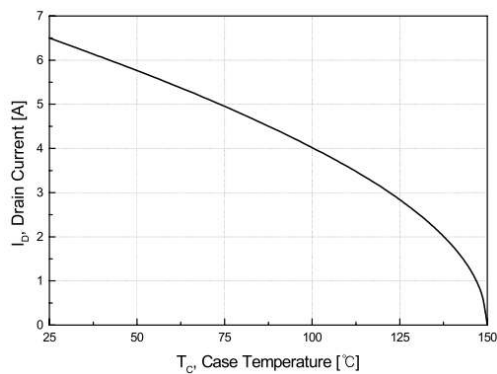


Fig. 5 Maximum Drain Current vs Case Temp.



TO-220 Package Dimension

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.7		10.1	0.382		0.398
B	6.3		6.7	0.248		0.264
C	9.0		9.47	0.354		0.373
D	12.8		13.3	0.504		0.524
E	1.2		1.4	0.047		0.055
F		1.7			0.067	
G		2.5			0.098	
H	3.0		3.4	0.118		0.134
I	1.25		1.4	0.049		0.055
J	2.4		2.7	0.094		0.106
K	5.0		5.15	0.197		0.203
L	2.2		2.6	0.087		0.102
M	1.25		1.55	0.049		0.061
N	0.45		0.6	0.018		0.024
O	0.6		1.0	0.024		0.039
ϕ		3.6			0.142	

